

## Features

- High Dense Cell Design For Extremely Low  $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

## Maximum Ratings

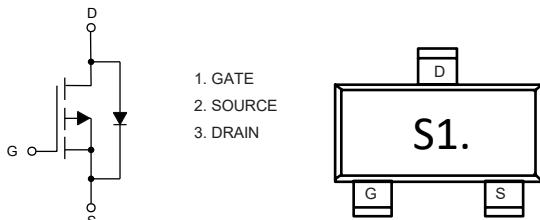
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 125°C/W Junction to Ambient<sup>(Note 2)</sup>

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	V
Continuous Drain Current $T_A=25^\circ\text{C}$	$I_D$	-2.8	A
$T_A=100^\circ\text{C}$		-1.8	
Pulsed Drain Current <sup>(Note 3)</sup>	$I_{DM}$	-11.2	A
Total Power Dissipation <sup>(Note 4)</sup>	$P_D$	1	W

Note:

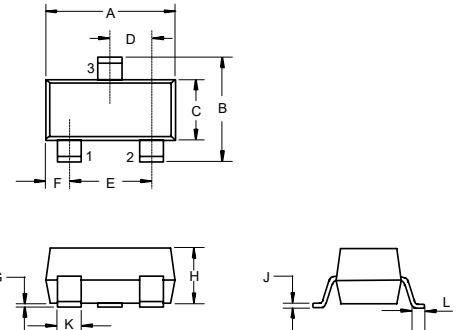
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .
3. Repetitive rating; pulse width limited by max. junction temperature.
4.  $P_D$  is based on max. junction temperature, using junction to ambient thermal resistance.

## Internal Structure and Marking Code



## P-Channel MOSFET

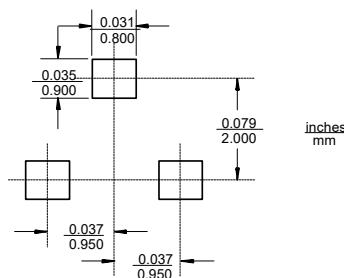
SOT-23



DIMENSIONS

DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.110	0.120	2.80	3.04	
B	0.083	0.104	2.10	2.64	
C	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
H	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

Suggested Solder Pad Layout

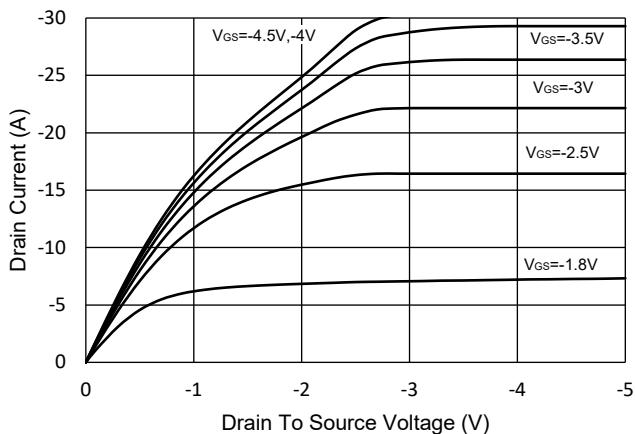


**Electrical Characteristics @ 25°C (Unless Otherwise Specified)**

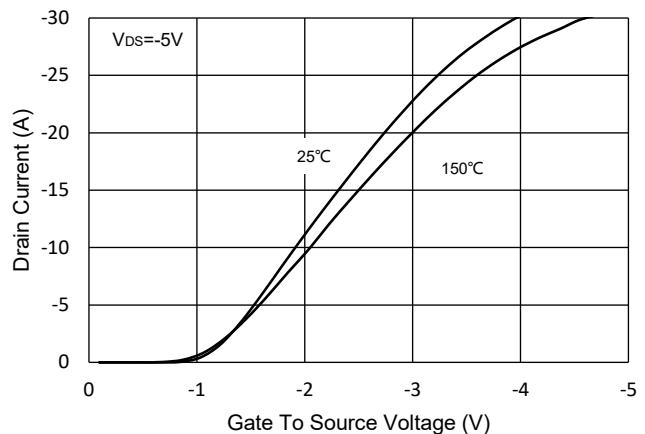
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-20			V
Gate-Source Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 8V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=-20V, V_{GS}=0V$			-1	$\mu A$
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.45	-0.7	-1.0	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-2.8A$		42	51	mΩ
		$V_{GS}=-2.5V, I_D=-2A$		55	67	
Gate Resistance	$R_g$	f=1 MHz, Open drain		14		Ω
<b>Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$				-2.8	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=-0.75A$			-1.2	V
Reverse Recovery Time	$t_{rr}$	$I_F=-1.4A, di/dt=100A/\mu s$		16		ns
Reverse Recovery Charge	$Q_{rr}$			4.7		nC
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=-15V, V_{GS}=0V, f=1MHz$		480		pF
Output Capacitance	$C_{oss}$			61		
Reverse Transfer Capacitance	$C_{rss}$			51		
Total Gate Charge	$Q_g$	$V_{DS}=-10V, V_{GS}=-4.5V, I_D=-1.4A$		8		nC
Gate-Source Charge	$Q_{gs}$			1.4		
Gate-Drain Charge	$Q_{gd}$			1.6		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=-10V, V_{GS}=-4.5V, R_G=6\Omega, I_D=-1.4A$		8		ns
Turn-On Rise Time	$t_r$			9		
Turn-Off Delay Time	$t_{d(off)}$			26		
Turn-Off Fall Time	$t_f$			10		

## Curve Characteristics

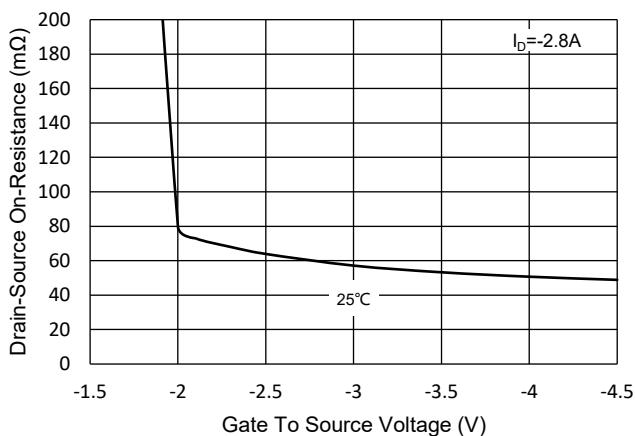
**Fig.1 - Typical Output Characteristics**



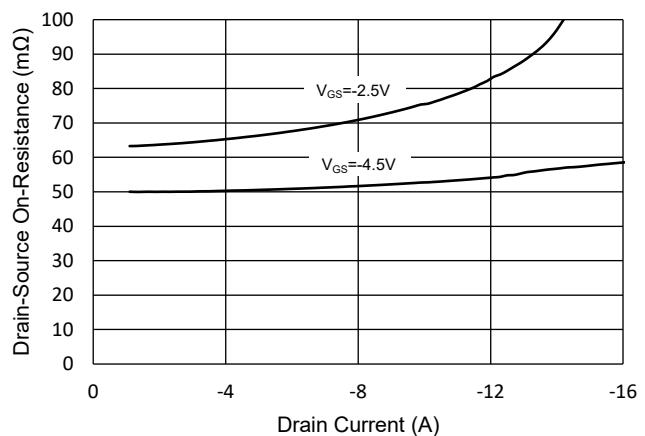
**Fig.2 - Transfer Characteristic**



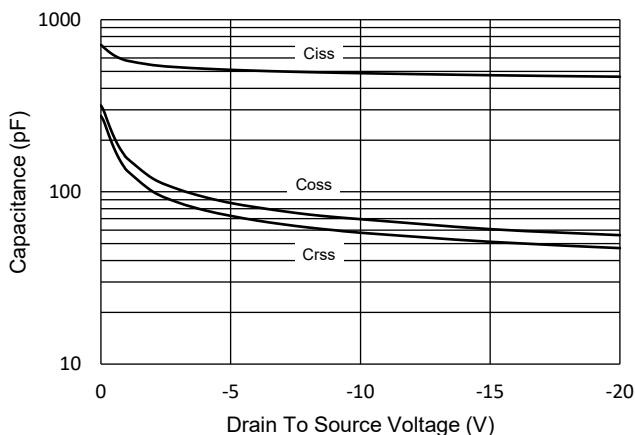
**Fig.3 -  $R_{DS(ON)}$  -  $V_{GS}$**



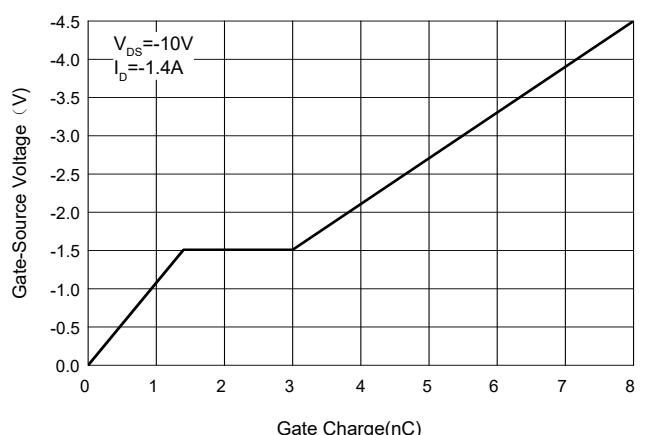
**Fig.4 -  $R_{DS(ON)}$  -  $I_D$**



**Fig.5 - Capacitance Characteristics**

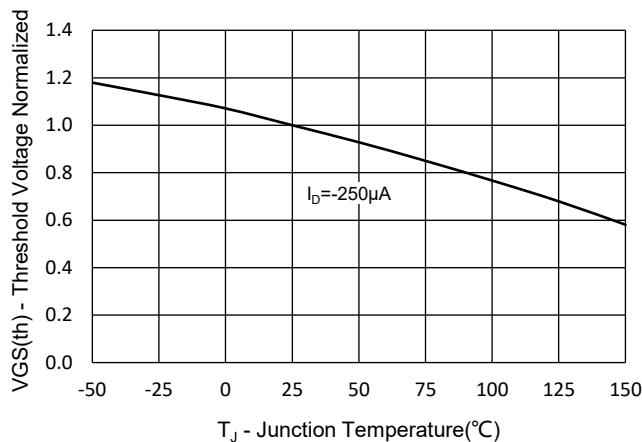


**Fig.6 - Gate Charge**

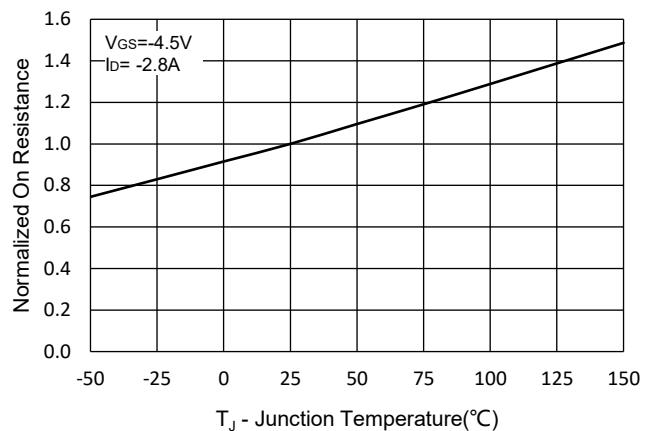


## Curve Characteristics

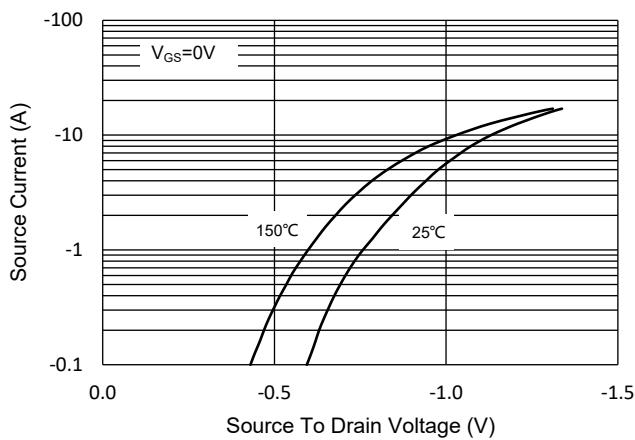
**Fig.7 - Normalized Threshold Voltage**



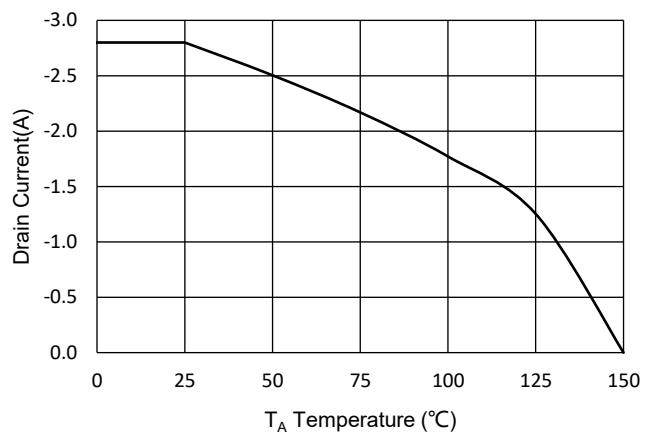
**Fig.8 - Normalized On Resistance Characteristics**



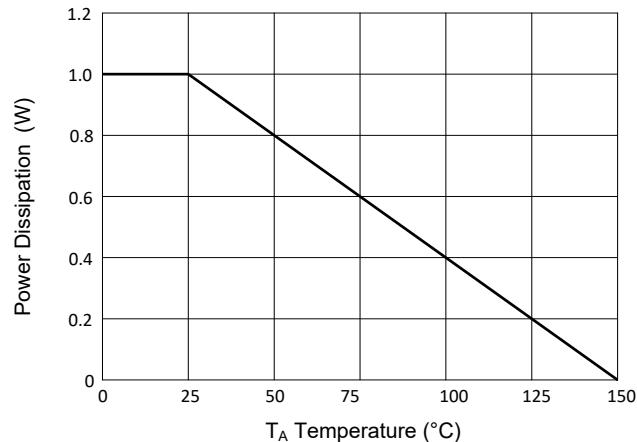
**Fig.9 - I<sub>S</sub> - V<sub>SD</sub>**



**Fig.10 - Drain Current**



**Fig.11-PD Dissipation**



## Curve Characteristics

Fig.12 - Safe Operation Area

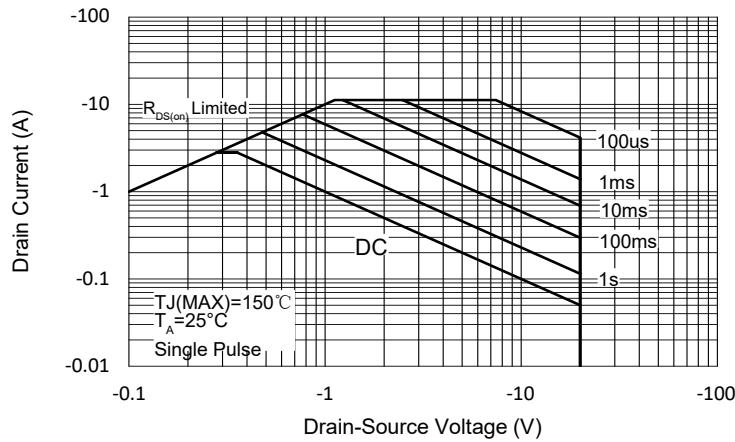
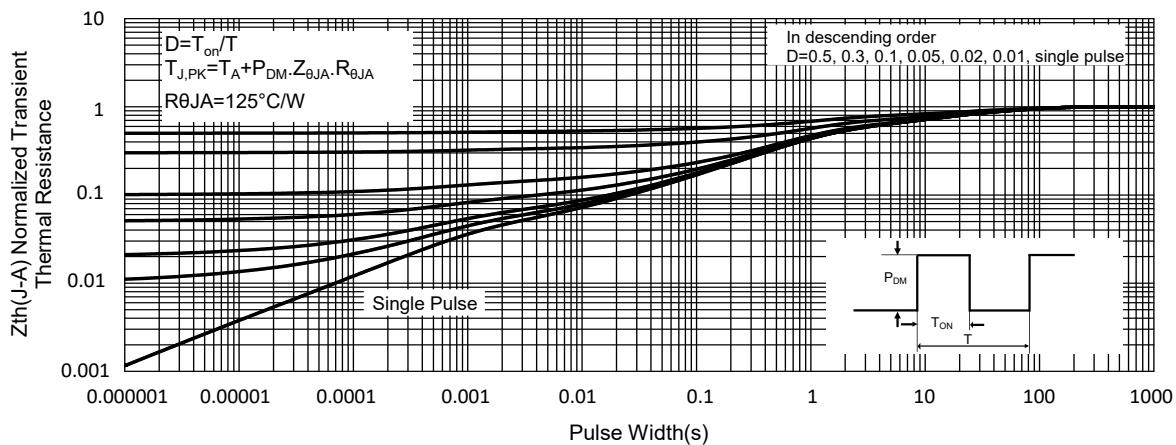


Fig.13 - Normalized Transient Thermal Impedance



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

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